2SD1994A

Silicon NPN epitaxial planar type

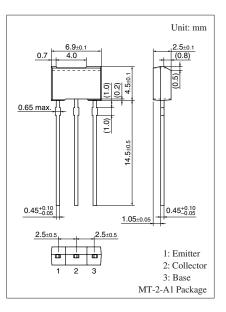
For low-frequency power strengthening and drive Complementary to 2SB1322A

Features

- \bullet Low collector-emitter saturation voltage $V_{CE(\text{sat})}$
- Allowing supply with the radial taping

Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V _{CBO}	60	V				
Collector-emitter voltage (Base open)	V _{CEO}	50	V				
Emitter-base voltage (Collector open)	V _{EBO}	5	V				
Collector current	I _C	1	А				
Peak collector current	I _{CP}	1.5	А				
Collector power dissipation *	P _C	1	W				
Junction temperature	Tj	150	°C				
Storage temperature	T _{stg}	-55 to +150	°C				





Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions Min		Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 2 {\rm mA}, I_{\rm B} = 0$				V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Forward current transfer ratio *1	h _{FE1} *2	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 500 \text{ mA}$	85		340	
	h _{FE2}	$V_{CE} = 5 V, I_C = 1 A$	50			
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		0.2	0.4	V
Base-emitter saturation voltage *1	V _{BE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		0.85	1.20	V
Transition frequency *1	f _T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		11	20	pF
(Common base, input open circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

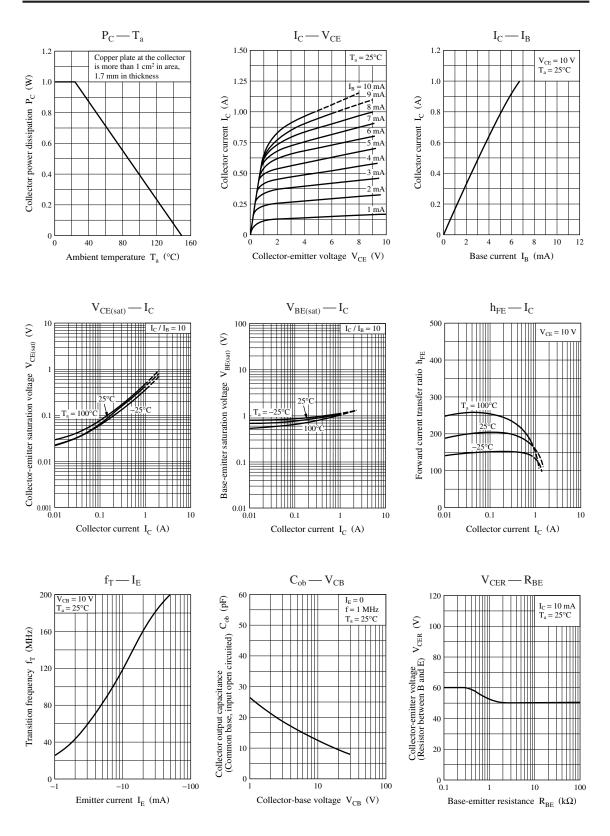
2. *1: Pulse measurement

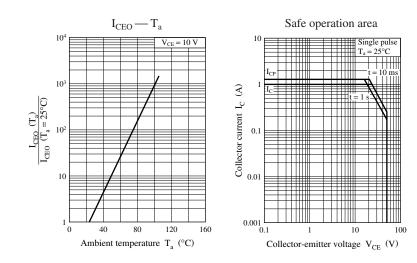
*2: Rank classification

Rank	Q	R	S	No rank
$h_{\rm FE1}$	85 to 170	120 to 240	170 to 340	85 to 340

Product of no-rank classification is not marked.

Panasonic





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